### HSMF-C114

## **Surface Mount Tricolor ChipLEDs**



## **Data Sheet**

### **Description**

The HSMF-C114 tricolor chip-type LED is designed in an ultra small package for miniaturiza-tion. It is the first of its kind to achieve such small packaging and be the thinnest package in the industry for tricolor package. With the freedom to have any combination of colors from mixing of the 3 primary colors, this will yield a wide variety of colors to suit every application and product theme.

The small size, narrow footprint, and low profile make this LED excellent for back-lighting, status indication, and front panel illumination applications.

In order to facilitate pick and place operation, this ChipLED is shipped in tape and reel, with 4000 units per reel. The package is compatible with reflow soldering and binned by both color and intensity.

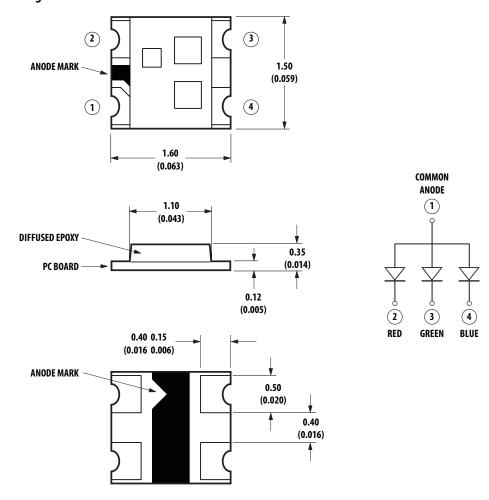
### **Features**

- Common anode
- Small 1.6 x 1.5 x 0.35 mm package
- Diffused optics
- Red/Green/Blue color combination
- Available in 8 mm tape on 7" diameter reels
- High brightness using AllnGaP and InGaN die technology
- Compatible with reflow soldering

### **Applications**

- Backlighting
- Status indicator
- Front panel indicator
- Office automation, home appliances, industrial equipment

## **Package Dimensions**



#### NOTES:

- 1. ALL DIMENSIONS IN MILLIMETERS (INCHES).
- 2. TOLERANCE IS 0.1 mm (0.004 IN.) UNLESS OTHERWISE SPECIFIED.

### Absolute Maximum Ratings at T<sub>A</sub> = 25°C

Parameter	AllnGaP Red	InGaN Green	InGaN Blue	Units
DC Forward Current <sup>[1,3]</sup>	20	20	20	mA
Power Dissipation <sup>[1]</sup>	48	78	78	mW
DC Forward Current <sup>[2]</sup>	15	15	15	mA
Power Dissipation <sup>[2]</sup>	36	59	59	mW
Reverse Voltage (I <sub>R</sub> = 100 μA)	5	5	5	V
LED Junction Temperature	95	95	95	°C
Operating Temperature Range		-40 to 85		°C
Storage Temperature Range		-40 to 85		°C
Soldering Temperature	See reflow soldering profile (Figures 6 & 7)			

#### Notes

- 1. Applies when single LED is lit up.
- 2. Applies when all 3 LEDs are lit up simultaneously.
- 3. Derate linearly as shown in Figure 4.
- 4. Drive currents above 5 mA are recommended for best long term performance.

### Electrical Characteristics at $T_A = 25$ °C

	Forward Voltage V <sub>F</sub> (Volts) <sup>[1]</sup> @ I <sub>F</sub> = 20 mA		Reverse Breakdown V <sub>R</sub> (Volts) @ I <sub>R</sub> = 100 μA	Capacitance C (pF), @ $V_F = 0$ , $f = 1$ MHz	
Part Number	Тур.	Max.	Min.	Тур.	
AllnGaP Red	1.9	2.4	5	10	
InGaN Green	3.4	3.9	5	65	
InGaN Blue	3.4	3.9	5	65	

#### Note:

1. VF tolerance:  $\pm$  0.1 V.

### Optical Characteristics at T<sub>A</sub> = 25°C

Luminous Intensity Iv <sup>[1]</sup> (mcd) @ 20 mA		•	Peak Wavelength λ <sub>peak</sub> (nm)	Color, Dominant Wavelength $\lambda_{\mathbf{d}}^{[2]}$ (nm)	Viewing Angle 2θ <sub>1/2</sub> <sup>[3]</sup> (Degrees)	Luminous Efficacy η <sub>v</sub> (lm/W)
Part Number	Min.	Typ.	Typical	Typical	Typical	Typical
AlinGaP Red	28.5	85.0	637	626	140	155
InGaN Green	45.0	180.0	523	525	145	477
InGaN Blue	28.5	70.0	468	470	145	75

#### Notes:

- 1. The luminous intensity IV is measured at the peak of the spatial radiation pattern which may not be aligned with the mechanical axis of the LED package.
- 2. The dominant wavelength, ld, is derived from the CIE Chromaticity Diagram and represents the perceived color of the device.
- 3. q1/2 is the off-axis angle where the luminous intensity is 1/2 the peak intensity.

### **CAUTION:**

- 1. The above optical performance specifications are valid in the case when single LED is lit up.
- 2. The above product specifications DO NOT provide any guarantee on color mixing, color consistency over time, or uniformity in luminous intensity when more than 1 LED is lit.
- 3. Please refer to Avago Technologies' Application Brief AB D-007 for additional details/explanation on driving the part in parallel circuit.

## Light Intensity (I<sub>V</sub>) Bin Limits<sup>[1]</sup>

	Intensity (mcd)		
Bin ID	Minimum	Maximum	
A	0.11	0.18	
В	0.18	0.29	
С	0.29	0.45	
D	0.45	0.72	
E	0.72	1.10	
F	1.10	1.80	
G	1.80	2.80	
Н	2.80	4.50	
J	4.50	7.20	
K	7.20	11.20	
L	11.20	18.00	
M	18.00	28.50	
N	28.50	45.00	
P	45.00	71.50	
Q	71.50	112.50	
R	112.50	180.00	
S	180.00	285.00	
Т	285.00	450.00	

Tolerance: ± 15%

#### Note:

 Bin categories are established for classification of products. Products may not be available in all categories. Please contact your Avago representative for information on current available bins.

### AlInGaP Red Color Bin Limits[1]

Dom. Wavelength (nm)			
Bin ID	Minimum	Maximum	
	620.0	635.0	

Tolerance: ± 1 nm

### InGaN Green Color Bin Limits[1]

	Dom. Wavelength (nm)		
Bin ID	Minimum	Maximum	
A	515.0	520.0	
В	520.0	525.0	
С	525.0	530.0	
D	530.0	535.0	

Tolerance: ± 1 nm

### InGaN Blue Color Bin Limits<sup>[1]</sup>

	Dom. Wavelength (nm)			
Bin ID	Minimum	Maximum		
A	460.0	465.0		
В	465.0	470.0		
С	470.0	475.0		
D	475.0	480.0		

Tolerance: ± 1 nm

### Note:

 Bin categories are established for classification of products. Products may not be available in all categories. Please contact your Avago representative for information on current available bins.

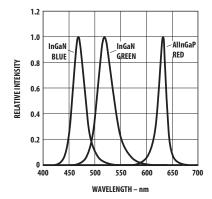


Figure 1. Relative intensity vs. wavelength.

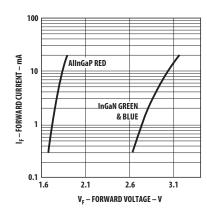


Figure 2. Forward current vs. forward voltage. Luminous intensity vs. forward current.

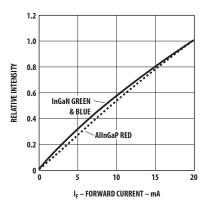


Figure 3. Luminous intensity vs. forward current.

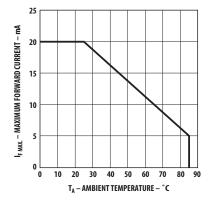


Figure 4. Maximum forward current vs. ambient temperature.

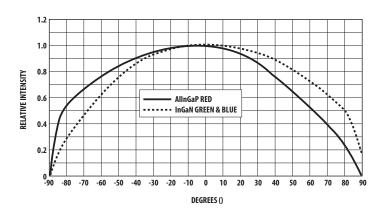


Figure 5. Relative intensity vs. angle.

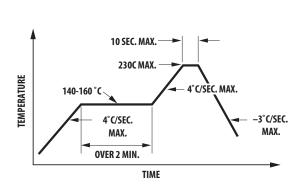


Figure 6. Recommended reflow soldering profile.

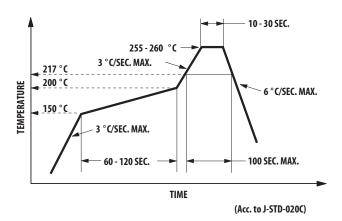


Figure 7. Recommended Pb-free reflow soldering profile.

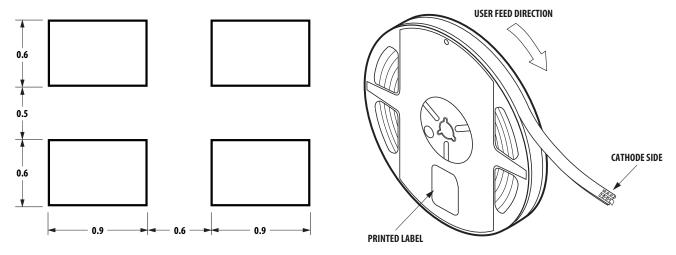


Figure 8. Recommended soldering land pattern.

Figure 9. Reeling orientation.

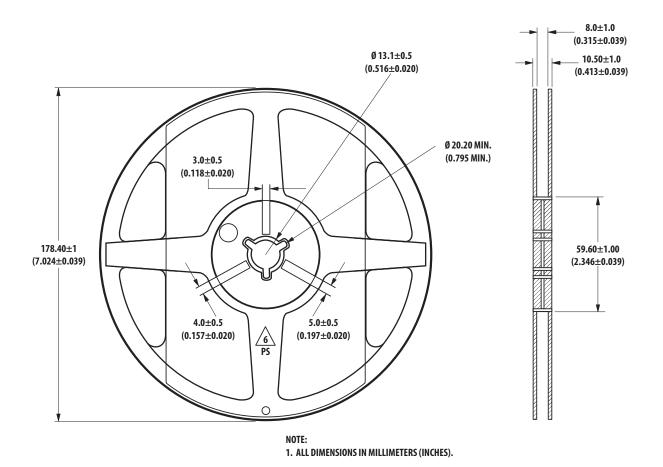


Figure 10. Reel dimensions.

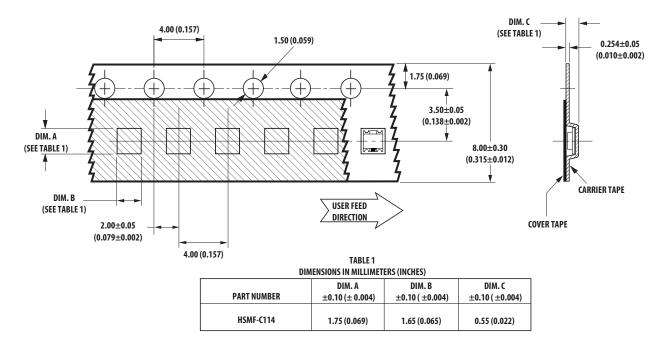


Figure 11. Tape dimensions.

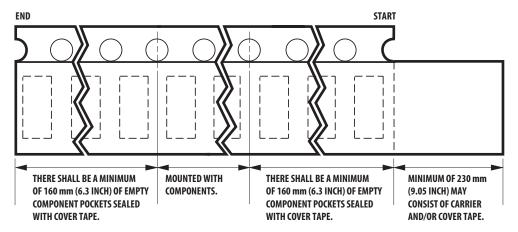


Figure 12. Tape leader and trailer dimensions.

### **Convective IR Reflow Soldering**

For more information on reflow soldering, refer to Application Note 1060, Surface Mounting SMT LED Indicator Components.

### **Storage Condition:**

5 to 30°C @ 60% RH max.

Baking is required before mounting if:

- 1. Humidity Indicator Card is > 10% when read at 23  $\pm$  5°C.
- 2. Device exposed to factory conditions  $< 30^{\circ}\text{C}/60\%$  RH more than 672 hours.

Recommended baking condition:  $60 \pm 5$ °C for 20 hours.

For product information and a complete list of distributors, please go to our web site:

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